MOS FET Power Amplifier Module for E-GSM900 and DCS1800 Dual Band Handy Phone

HITACHI

ADE-208-685B (Z) 3rd Edition Apr. 1999

Application

- Dual band amplifier for E-GSM900 (880 to 915 MHz) and DCS1800 (1710 to 1785 MHz).
- For 4.8 V nominal battery use

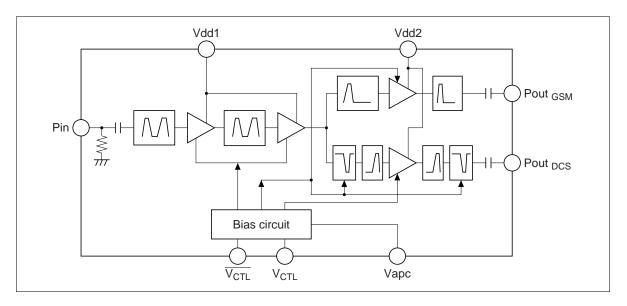
Features

- 1 in / 2 out dual band amplifier
- Simple external circuit including output matching circuit
- Simple band switching and power control
- High gain 3stage amplifier: +4.5 dBm input
- Lead less thin & Small package: $11 \times 13.75 \times 1.8$ mm
- High efficiency: 48% Typ at 34.5 dBm for E-GSM

36% Typ at 31.5 dBm for DCS1800



Internal Circuit Block Diagram



Band Select and Power Control (H: 2 V Min, L: 0.3 V Max)

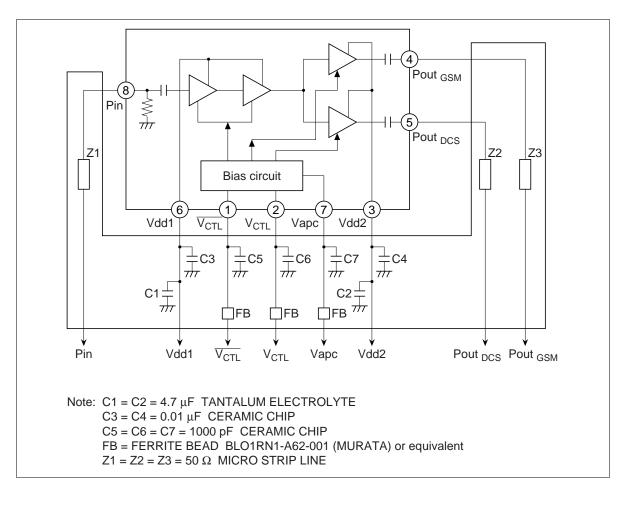
Operating Mode	$\mathbf{V}_{\mathtt{CTL}}$	$\overline{V_{CTL}}$	Vapc	
GSM Tx ON	Н	L	Control	
DCS Tx ON	L	Н	Control	
Tx OFF	L	L	< 0.2 V	

Current of Control Pin

Control Pin	Equivalent Input Circuit	Control Current
V _{CTL}		160 μA Max at 3 V
V _{CTL}		80 μA Max at 3 V
Vapc		3 mA Max at 3 V

HITACHI

Internal Diagram and External Circuit



Absolute Maximum Ratings (Tc = 25°C)

Item	Symbol	Rating	Unit		
Supply voltage	V_{DD}	8.5	V		
Supply current	I _{DD GSM}	3	А		
	I _{DD DCS}	3	А		
V_{CTL} , $\overline{V_{\text{CTL}}}$ voltage	$V_{\text{CTL}}, \overline{V_{\text{CTL}}}$	4	V		
Vapc voltage	Vapc	4	V		
Input power	Pin	10	dBm		
Operating case temperature	Tc (op)	-30 to +100	°C		
Storage temperature	Tstg	-30 to +100	°C		
Output power	Pout _{GSM}	5	W		
	Pout nos	3	W		

Note: The maximum ratings shall be valid over both the E-GSM-band (880-915 MHz), and the DCS-band (1710-1785 MHz).

Electrical Characteristics for DC (Tc = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Drain cutoff current	lds	_	_	20	μΑ	$Vdd = 6.0 \text{ V}, Vapc = 0 \text{ V},$ $V_{CTL} = 0 \text{ V}, \overline{V_{CTL}} = 0 \text{ V}$
		_	_	300	μΑ	$Vdd = 8.5 \text{ V}, Vapc = 0 \text{ V}, \ V_{CTL} = 0 \text{ V}, \ \overline{V_{CTL}} = 0 \text{ V}, \ Tc = -20 \text{ to } +80^{\circ}\text{C}$
V _{CTL} control current	I _{CTL}	_	100	160	μΑ	V _{CTL} = 3.0 V
V _{CTL} control current	I _{CTL}	_	50	80	μΑ	$\overline{V_{CTL}} = 3.0 \text{ V}$

Electrical Characteristics for GSM900 mode ($Tc = 25^{\circ}C$)

Test conditions unless otherwise noted:

f=880 to 915MHz, Vdd1 = Vdd2 = 4.8V, Pin = +4.5dBm, V_{CTL} = 2.0V, $\overline{V_{CTL}}$ = 0.3V, Rg = R1 = 50 Ω , Tc = 25°C, Pulse operation with pulse width 577 μs and duty cycle 1:8 shall be used.

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Frequency range	f	880	_	915	MHz	
Control voltage range	Vapc	0.2	_	3.0	V	
Vapc control current	lapc	_	_	3	mA	Vapc = 3.0V
Total efficiency	$\eta_{\scriptscriptstyle T}$	43	48	_	%	Pout _{GSM} = 34.5dBm,
2nd harmonic distortion	2nd H.D.	_	-45	-35	dBc	Vapc = control
3rd harmonic distortion	3rd H.D.	_	-45	-35	dBc	_
4th~8th harmonic distortion	4th~8th H.D.	_	_	-35	dBc	
Input VSWR	VSWR (in)	_	2	3	_	
Output power (1)	Pout (1)	35.0	35.7	_	dBm	Vapc = 3.0V
Output power (2)	Pout (2)	33.0	34.0	_	dBm	Vdd = 4.2V, Vapc = 3.0V, Tc = +85°C, Pin = +3dBm
Isolation	_	_	-40	-20	dBm	Vapc = 0.2 V
Isolation at DCS RF-output when GSM is active	_	_	-30	-20	dBm	Pout _{GSM} = 34.5dBm (GSM mode) Measured at f = 1760 to 1830MHz
Switching time	tr, tf	_	1	2	μs	Pout _{GSM} = -15 to 35.0dBm
Stability	_		No parasitic oscillation All spuriouses < –36 dBm			$V_{DD}=4.2$ to 6.3V, Pout \leq 35.0dBm, Vapc \leq 3.0V GSM pulse. Rg = 50 Ω , Tc = -20 to +85°C, Output VSWR = 6 : 1 All phases, RES BW = 3MHz
Load VSWR tolerance	_	No degradation or Permanent degradation			_	$V_{DD}=4.2$ to 6.3V, Pout $_{GSM}\leq 35.0$ dBm, Vapc ≤ 3.0 V GSM pulse. Rg = 50Ω , t = 30 sec., Tc = -20 to $+85$ °C, Output VSWR = $10:1$ All phases
Noise power	Pnoise1	_	_	-73	dBm	f0 = 915MHz, frx = f0 +10MHz Pout _{GSM} = 35dBm, RES BW = 100kHz
	Pnoise2	_	_	-85	dBm	f0 = 915MHz, frx = f0 +20MHz Pout _{GSM} = 35dBm, RES BW = 100kHz
	Pnoise3	_	_	-77	dBm	frx = 1805 to 1880MHz Pout _{GSM} = 35dBm, RES BW = 100kHz
				200	dB/V	Pout _{GSM} = 0 to 35dBm

HITACHI

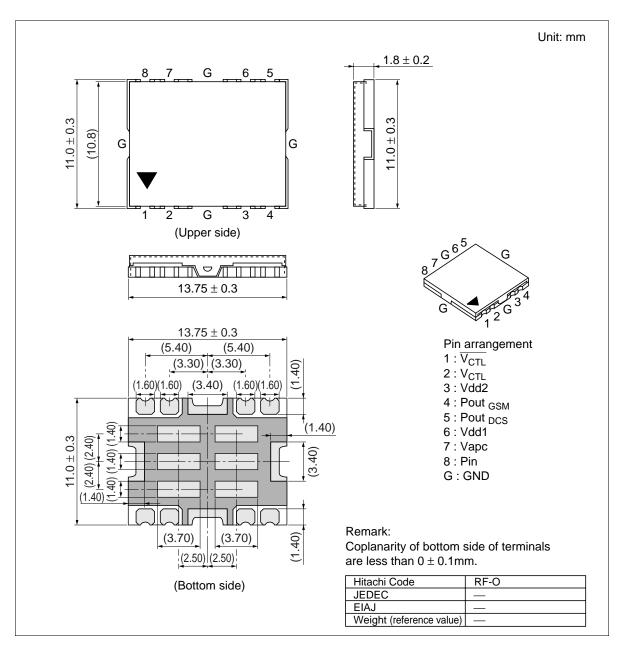
Electrical Characteristics for DCS1800 mode (Tc = 25°C)

Test conditions unless otherwise noted:

f=1710 to $1785MHz,\ Vdd1=Vdd2=4.8V,\ Pin=+4.5dBm,\ V_{CTL}=0.3V,\ \overline{V_{CTL}}=2.0V,\ Rg=Rl=50\Omega,$ $Tc=25^{\circ}C,\ Pulse\ operation\ with\ pulse\ width\ 577\ \mu s$ and duty cycle 1:8 shall be used.

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Frequency range	f	1710	_	1785	MHz	
Control voltage range	Vapc	0.2	_	3.0	V	
Vapc control current	lapc	_	_	3	mA	Vapc = 3.0V
Total efficiency	η_{T}	33	36	_	%	Pout _{DCS} = 31.5dBm,
2nd harmonic distortion	2nd H.D.	_	-45	-35	dBc	Vapc = control
3rd harmonic distortion	3rd H.D.	_	-45	-35	dBc	-
4th~8th harmonic distortion	4th~8th H.D.	_	_	-35	dBc	-
Input VSWR	VSWR (in)	_	3	5	_	-
Output power (1)	Pout (1)	32.5	33.0	_	dBm	Vapc = 3.0V
Output power (2)	Pout (2)	31	31.5	_	dBm	Vdd = 4.8V, Vapc = 3.0V, Tc = +85°C, Pin = +3dBm
Isolation	_	_	-35	-30	dBm	Vapc = 0.2V
Switching time	tr, tf	_	1	2	μs	Pout _{DCS} = -15 to 32.0dBm
Stability	_	No parasitic oscillation		_	V_{DD} = 4.2 to 6.3V, Pout $_{DCS}$ \leq 32.5dBm, Vapc \leq 3.0V DCS pulse. Rg = 50 Ω , Tc = -20 to +85°C, Output VSWR = 6 : 1 All phases	
Load VSWR tolerance	_	No degradation		_	V_{DD} = 4.2 to 6.3V, Pout $_{DCS}$ \leq 32.5dBm, Vapc \leq 3.0V DCS pulse. Rg = 50 Ω , t = 30sec., Tc = -20 to +85°C, Output VSWR = 10 : 1 All phases	
Noise power	Pnoise1	_	_	-77	dBm	f0 = 1785MHz, frx = f0 +20MHz, Pout _{DCS} = 31.5dBm, RES BW = 30kHz
	Pnoise2	_	_	-7 4	dBm	frx = 925 to 935MHz, Pout $_{DCS}$ = 31.5dBm, RES BW = 30kHz
	Pnoise3	_	_	-85	dBm	frx = 935 to 960MHz, Pout $_{\rm DCS}$ = 31.5dBm, RES BW = 30kHz
Slope Pout/Vapc	_	_	_	200	dB/V	Pout _{DCS} = 0 to 32.0dBm
Intermodulation		_	_	-20	dBm	Pout = 31.5dBm, Interferer.CW f0 +800kHz, Pinterfer = -9dBm, RES BW = 300kHz, Measure at f0 -800kHz

Package Dimensions



HITACHI

Cautions

- 1. Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
- 2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
- 3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
- 4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as fail-safes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
- 5. This product is not designed to be radiation resistant.
- 6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
- 7. Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.

HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.

Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL NorthAmerica : http:semiconductor.hitachi.com/

URL NorthAmerica Europe Asia (Singapore) Asia (Taiwan) Asia (HongKong)

: http://www.hitachi-eu.com/hel/ecg
pore) : http://www.has.hitachi.com.sg/grp3/sicd/index.htm
n) : http://www.hitachi.com.tw/E/Product/SICD_Frame.htm
long) : http://www.hitachi.com.hk/eng/bo/grp3/index.htm

Japan : http://www.hitachi.co.jp/Sicd/indx.htm

For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Hitachi Europe GmbH Electronic components Group Dornacher Stra§e 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.

Electronic Components Group.

Whitebrook Park Lower Cookham Road Maidenhead

Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000

Tel: <44> (1628) 585000 Fax: <44> (1628) 778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building. No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666

Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218

Fax: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

Copyright ' Hitachi, Ltd., 1999. All rights reserved. Printed in Japan.